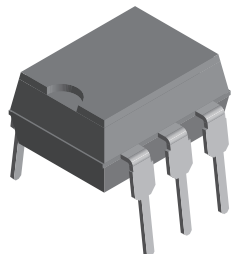
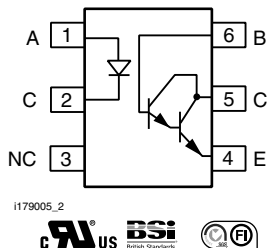


Optocoupler, Photodarlington Output, High Gain, with Base Connection



i179004-3



i179005_2



FEATURES

- Isolation test voltage, 5300 V_{RMS}
- Coupling capacitance, 0.5 pF
- Fast rise time, 10 μ s
- Fast fall time, 35 μ s
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC


RoHS
COMPLIANT

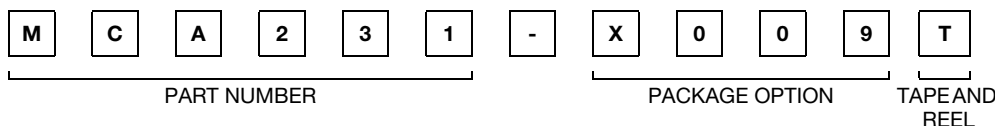
AGENCY APPROVALS

- UL1577, file no. E52744 system code H, double protection
- CSA 93751
- BSI IEC 60950; IEC 60065

DESCRIPTION

The MCA231 is a industry standard optocoupler, consisting of a gallium arsenide infrared LED and a silicon photodarlington. These optocouplers are constructed with a high voltage insulation packaging process which offers 7.5 kV withstand test capability.

ORDERING INFORMATION



AGENCY CERTIFIED/PACKAGE	CTR (%)
	10 mA
UL, BSI, VDE	> 200
DIP-6	MCA231
SMD-6, option 9	MCA231-X009T ⁽¹⁾

Note

- For additional information on the available options refer to option information.
- ⁽¹⁾ Also available in tubes, do not put T on the end.

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)

PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT
INPUT					
Reverse voltage			V _R	6	V
Forward continuous current			I _F	60	mA
Power dissipation			P _{diss}	135	mW
Derate linearly from 25 °C				1.8	mW/°C
OUTPUT					
Collector emitter breakdown voltage		MCA231	BV _{CEO}	30	V
Emitter collector breakdown voltage			BV _{ECO}	7	V
Collector base breakdown voltage		MCA231	BV _{CBO}	30	V
Power dissipation			P _{diss}	210	mW
Derate linearly from 25 °C				2.8	mW/°C

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)					
PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT
COUPLER					
Total package dissipation (LED plus detector)			P_{tot}	260	mW
Derate linearly from 25 °C				3.5	mW/°C
Storage temperature			T_{stg}	- 55 to + 150	°C
Operating temperature			T_{amb}	- 55 to + 100	°C
Lead soldering time at 260 °C				10	s
Isolation test voltage			V_{ISO}	5300	V_{RMS}
Isolation resistance	$V_{IO} = 500\text{ V}$, $T_{amb} = 25\text{ }^{\circ}\text{C}$		R_{IO}	10^{12}	Ω
	$V_{IO} = 500\text{ V}$, $T_{amb} = 100\text{ }^{\circ}\text{C}$		R_{IO}	10^{11}	Ω

Note

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT							
Forward voltage	$I_F = 50\text{ mA}$		V_F		1.1	1.5	V
Reverse current	$V_R = 3\text{ V}$		I_R			10	μA
Junction capacitance	$V_R = 3\text{ V}$		C_j		50		pF
OUTPUT							
Collector emitter breakdown voltage	$I_C = 100\text{ }\mu\text{A}$, $I_F = 0\text{ mA}$	MCA231	BV_{CEO}	30			V
Emitter collector breakdown voltage	$I_E = 10\text{ }\mu\text{A}$, $I_F = 0\text{ mA}$		BV_{ECO}	7			V
Collector base breakdown voltage	$I_C = 10\text{ }\mu\text{A}$, $I_F = 0\text{ mA}$	MCA231	BV_{CBO}	30			V
Collector emitter leakage current			I_{CEO}			100	nA
COUPLER							
Collector emitter saturation voltage	$I_C = 2\text{ mA}$, $I_F = 16\text{ mA}$		V_{CEsat}			0.8	V
	$I_C = I_F = 50\text{ mA}$		V_{CEsat}			1	V
	$I_C = 2\text{ mA}$, $I_F = 1\text{ mA}$		V_{CEsat}			1	V
	$I_C = 10\text{ mA}$, $I_F = 5\text{ mA}$		V_{CEsat}			1	V
	$I_C = 50\text{ mA}$, $I_F = 10\text{ mA}$		V_{CEsat}			1.2	V
Capacitance (input to output)			C_{IO}		0.5		pF

Note

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

CURRENT TRANSFER RATIO ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
DC current transfer ratio	$V_{CE} = 5\text{ V}$, $I_F = 10\text{ mA}$	CTR_{DC}	200			%

SWITCHING CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Switching times	$R_L = 100\text{ }\Omega$, $V_{CE} = 10\text{ V}$	t_{on}		10		μs
		t_{off}		30		μs

Optocoupler, Photodarlington Output, Vishay Semiconductors High Gain, with Base Connection

TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

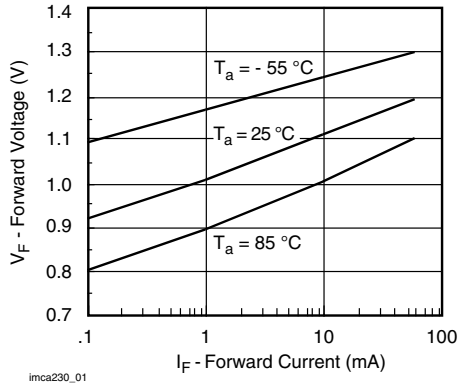


Fig. 1 - Forward Voltage vs. Forward Current

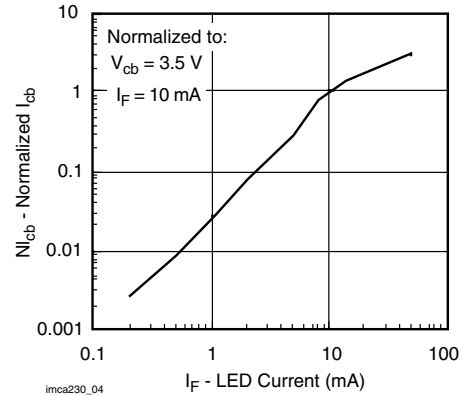


Fig. 4 - Normalized Collector Base Photocurrent vs. LED Current

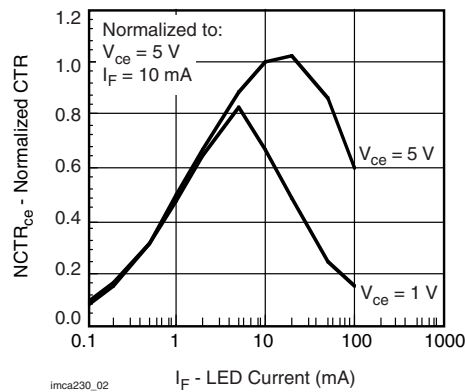


Fig. 2 - Normalized Non-Saturated and Saturated CTR vs. LED Current

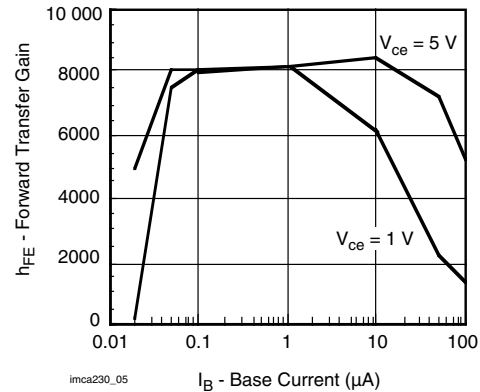


Fig. 5 - Non Saturated and Saturated h_{FE} vs. Base Current

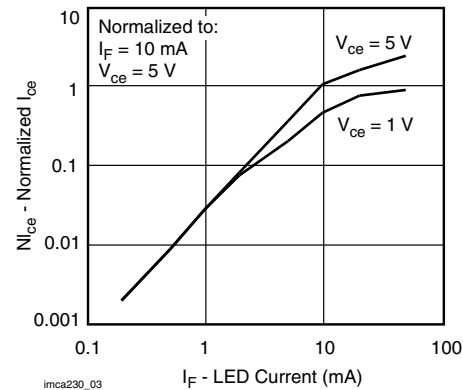


Fig. 3 - Normalized Non-Saturated and Saturated Collector Emitter Current vs. LED Current

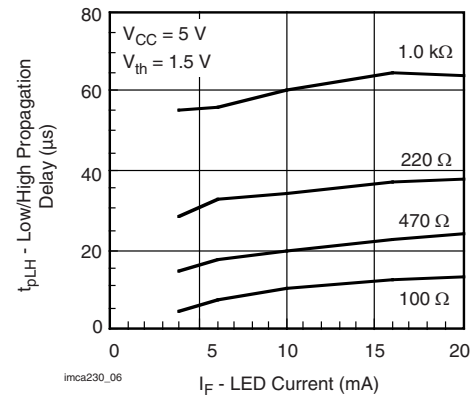


Fig. 6 - Low to High Propagation Delay vs. Collector Load Resistance and LED Current

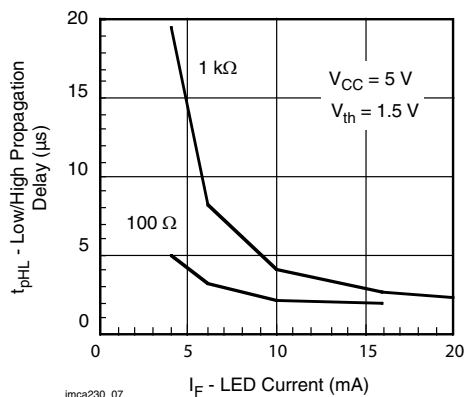


Fig. 7 - High to low Propagation Delay vs. Collector Load Resistance and LED Current

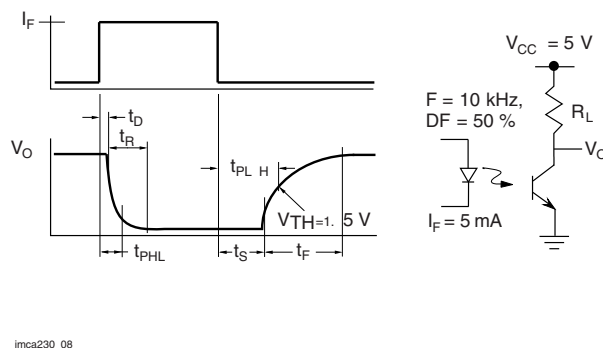
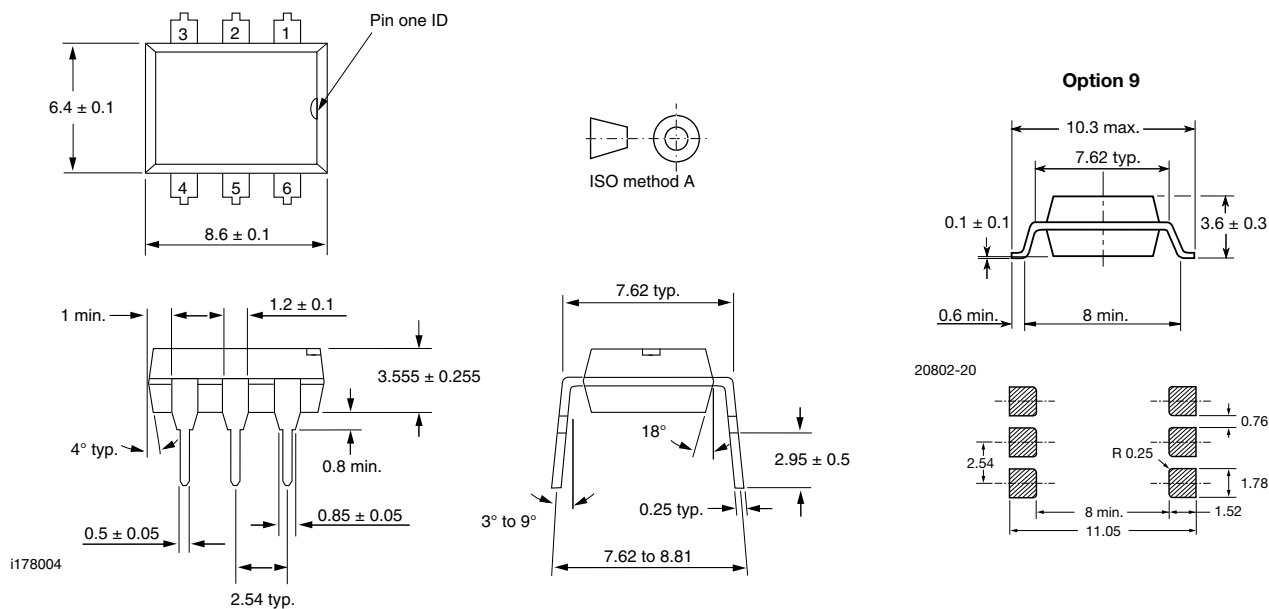
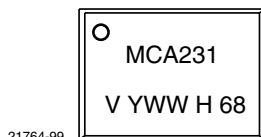


Fig. 8 - Switching Timing Waveform and Schematic

PACKAGE DIMENSIONS in millimeters



PACKAGE MARKING

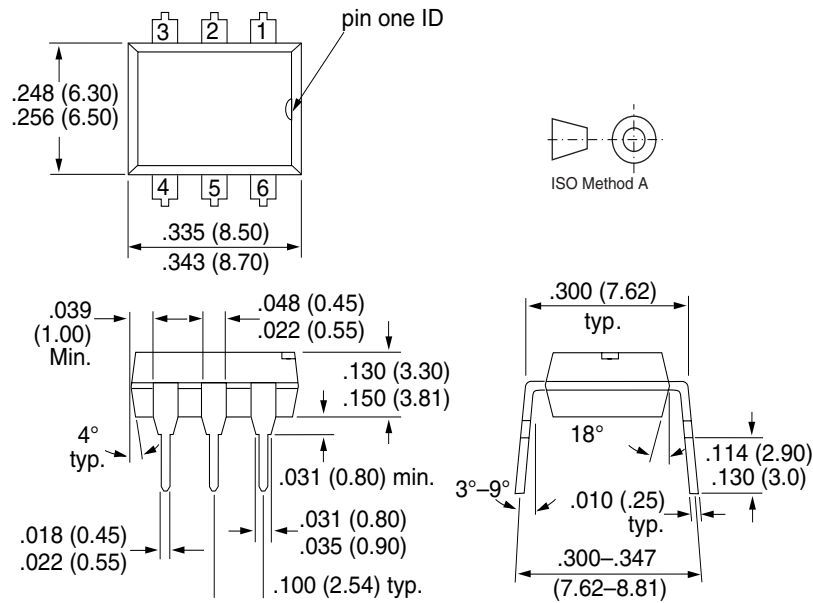


Note

- Tape and reel suffix (T) is not part of the package marking.

DIP-6A

Package Dimensions in Inches (mm)



i178004



Ozone Depleting Substances Policy Statement

It is the policy of **Vishay Semiconductor GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

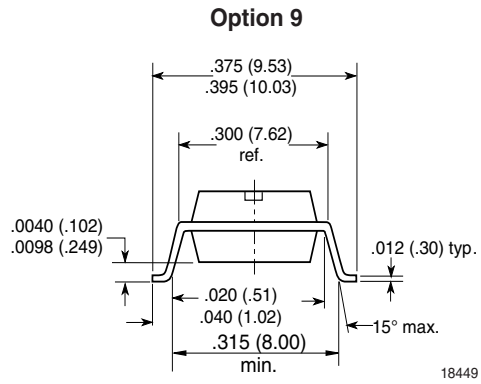
**We reserve the right to make changes to improve technical design
and may do so without further notice.**

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany
Telephone: 49 (0)7131 67 2831, Fax number: 49 (0)7131 67 2423



Option 9





Ozone Depleting Substances Policy Statement

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Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany
Telephone: 49 (0)7131 67 2831, Fax number: 49 (0)7131 67 2423

Footprints

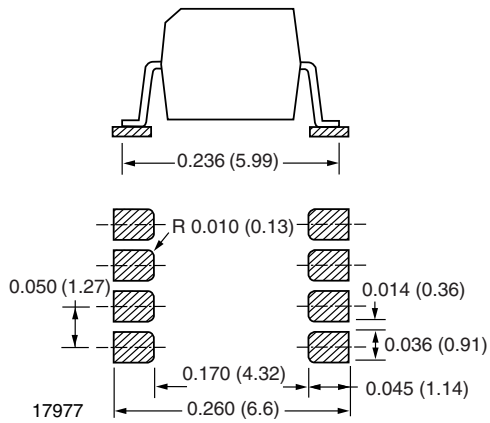


Fig. 1 - SO8A and DSO8A SMD

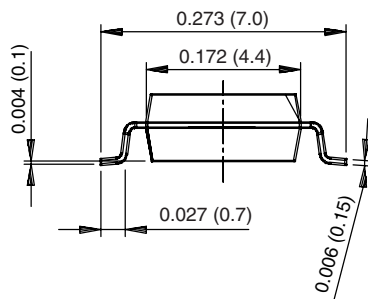


Fig. 2 - SOP-4, Miniflat

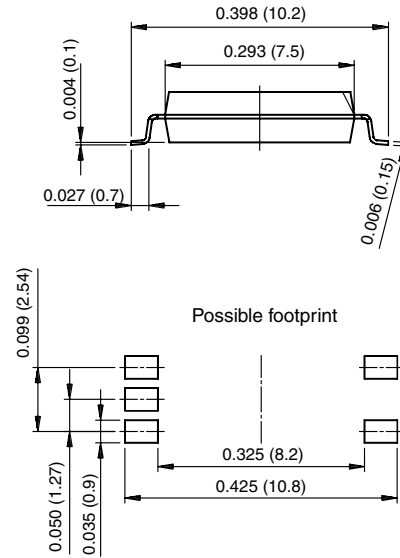


Fig. 3 - SOP-6, 5 Pin Wide Body

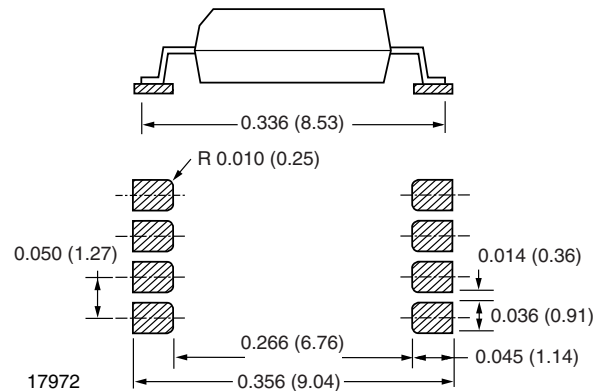


Fig. 4 - 8 Pin PCMCIA

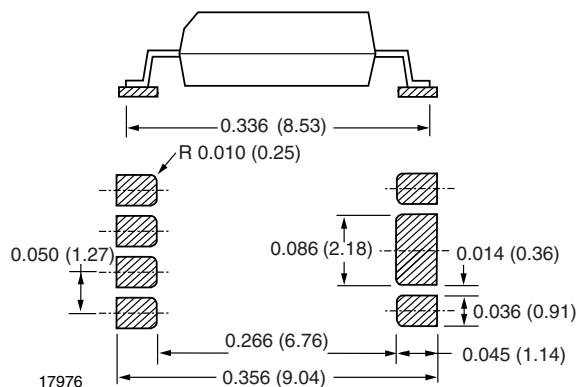


Fig. 5 - 8 Pin PCMCIA, Heat Sink

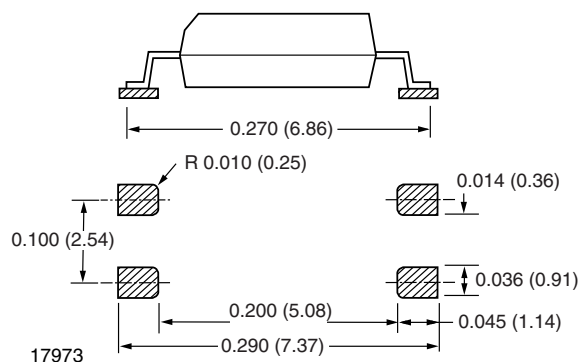


Fig. 8 - 4 Pin Mini-Flat

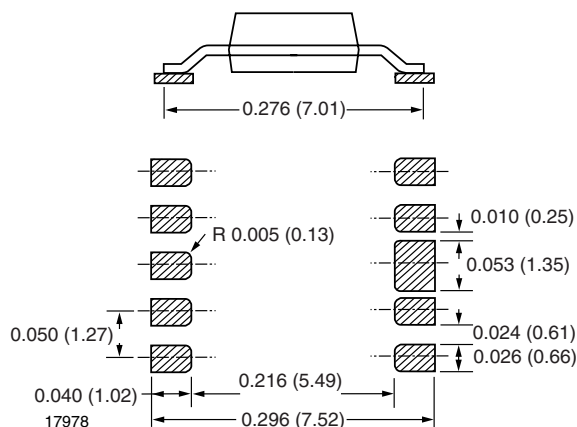


Fig. 6 - Mini Coupler

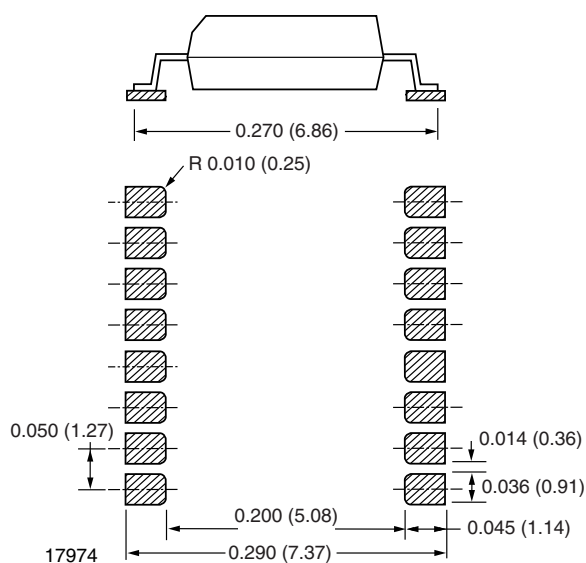


Fig. 7 - SOP-16

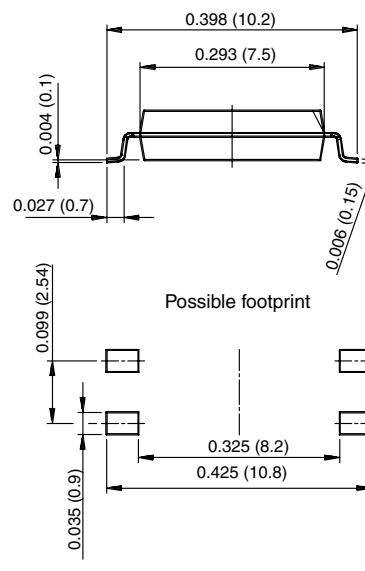


Fig. 9 - SOP-6, 4 Pin Wide Body

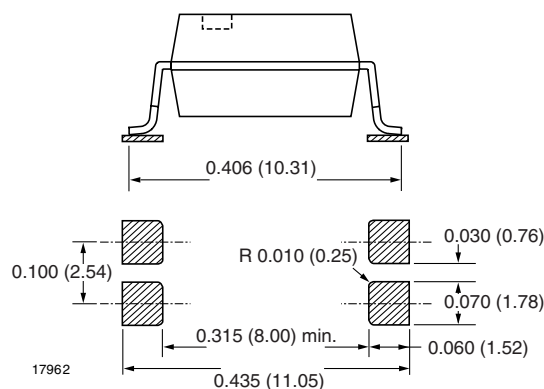


Fig. 10 - 4 Pin SMD Option 7

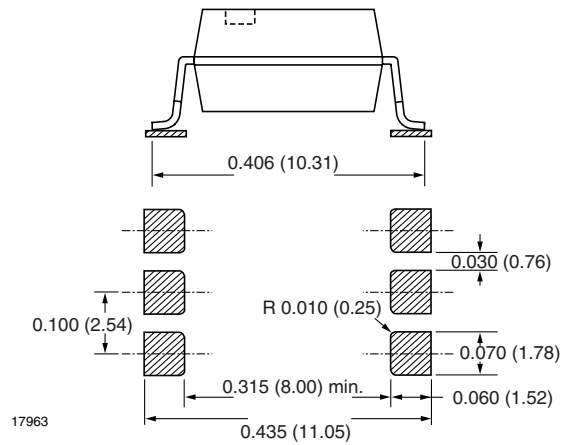


Fig. 11 - 6 Pin SMD Option 7

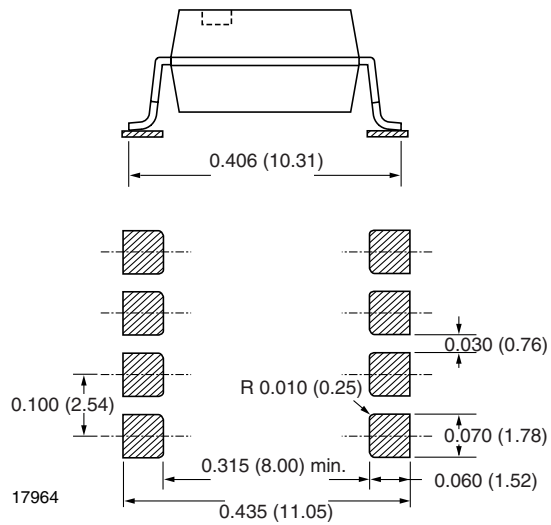


Fig. 12 - 8 Pin SMD Option 7

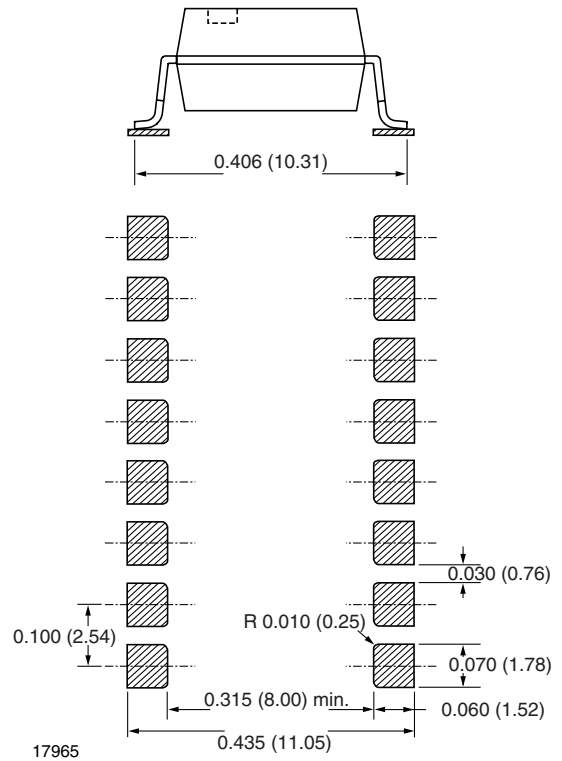


Fig. 13 - 16 Pin SMD Option 7

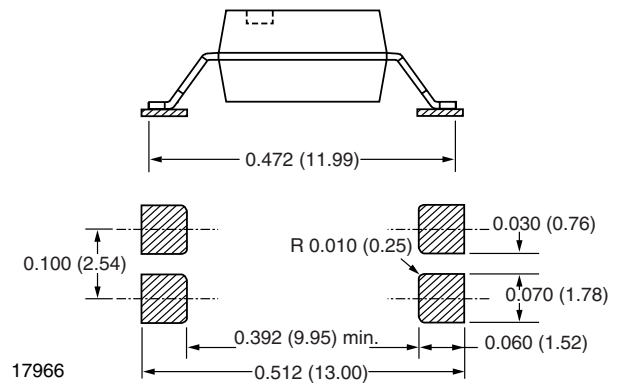


Fig. 14 - 4 Pin SMD Option 8

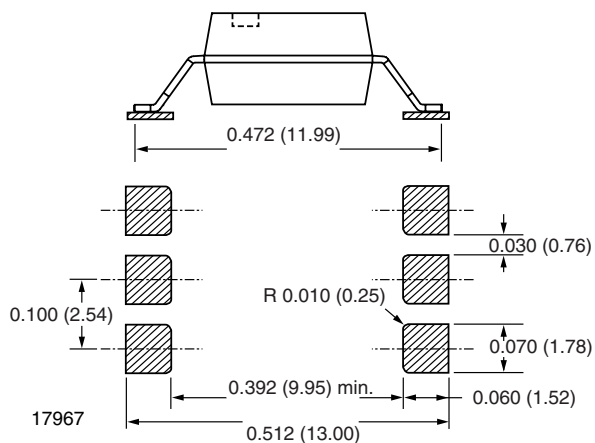


Fig. 15 - 6 Pin SMD Option 8

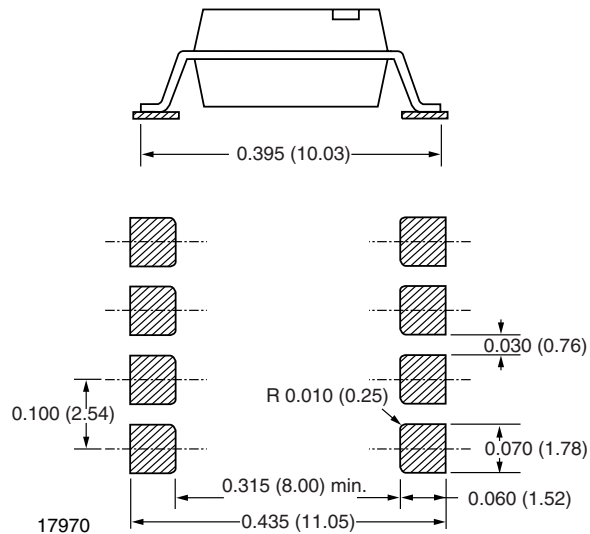


Fig. 18 - 8 Pin SMD Option 9

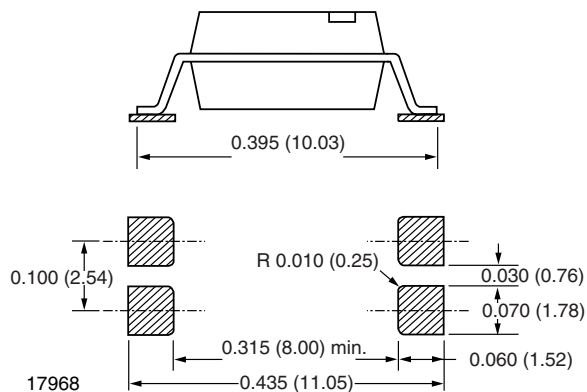


Fig. 16 - 4 Pin SMD Option 9

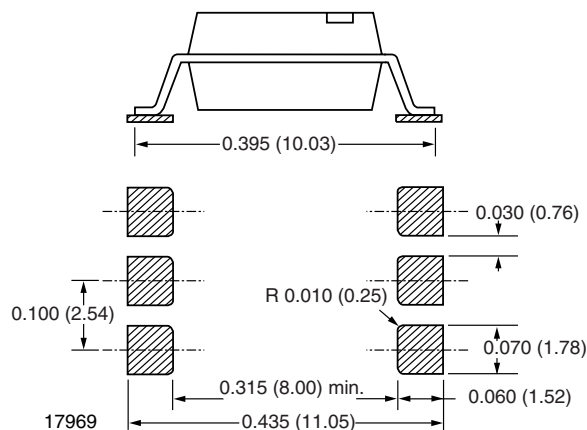


Fig. 17 - 6 Pin SMD Option 9

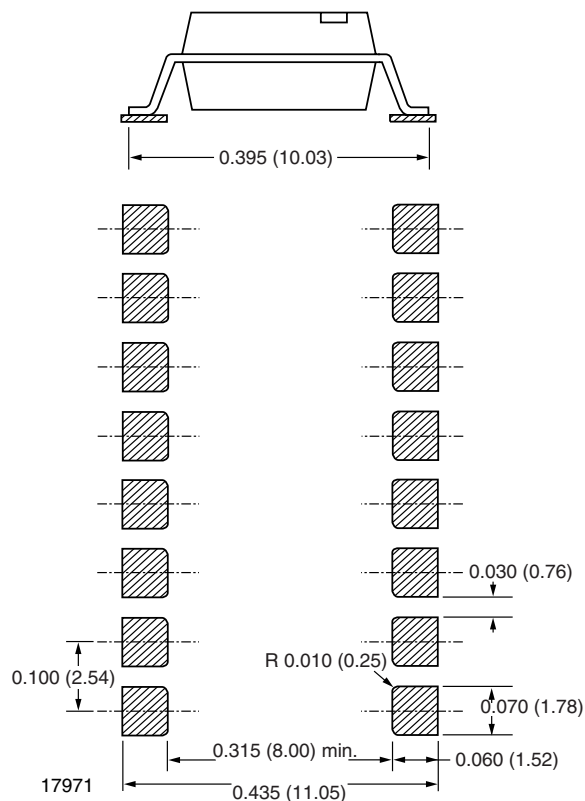
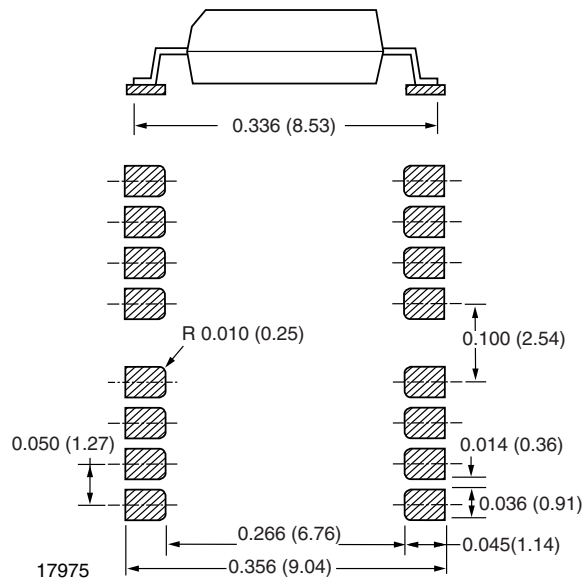


Fig. 19 - 16 Pin SMD Option 9





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